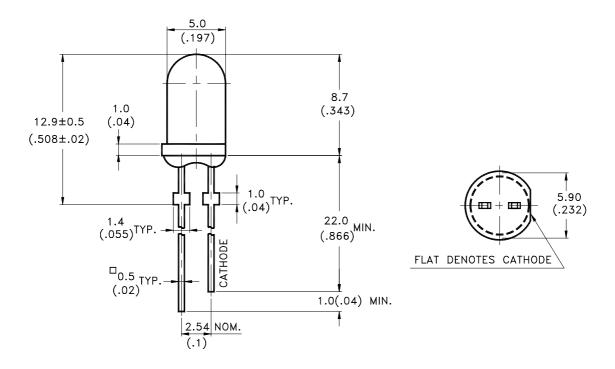


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#### **Features**

- \* High luminous intensity output.
- \* Low power consumption.
- \* High efficiency.
- \* Versatile mounting on PCB or panel.
- \* I.C. Compatible / low current requirements.
- \* Popular T-1 3/4 diameter.

## **Package Dimensions**



Part No.	Lens	Source Color
LTL2H3TCKS7-032A	Water Clear	InGaN Bluish-Green

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm(.010") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

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# Absolute Maximum Ratings at TA=25

Parameter	Maximum Rating	Unit
Power Dissipation	130	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA
DC Forward Current	30	mA
Reverse Voltage	5	V
Operating Temperature Range	-40 to +80	
Storage Temperature Range	-55 to + 100	
Lead Soldering Temperature [1.6mm(.063") From Body]	260 for 5 Seconds	

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### Electrical / Optical Characteristics at Ta=25

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	4200	9300		mcd	IF = 20mA Note 1,5
Viewing Angle	201/2		15		deg	Note 2 (Fig.5)
Peak Emission Wavelength	λР		505		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd		503		nm	Note 4
Spectral Line Half-Width	Δλ		35		nm	
Forward Voltage	$V_{\mathrm{F}}$		3.4	4.3	V	$I_F = 20 \text{mA}$
Reverse Current	IR			100	μΑ	$V_R = 5V$
Capacitance	С		40		pF	$V_F = 0$ , $f = 1MHz$

NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2.  $\theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength,  $\lambda d$  is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Iv classification code is marked on each packing bag.
- 5. The Iv guarantee should be added  $\pm 15$  % tolerance.
- 6. Precautions in handling:

When soldering, leave 2mm of minimum clearance from the resin to the soldering point.

Dipping the resin to solder must be avoided.

Correcting the soldered position after soldering must be avoided.

In soldering, do not apply any stress to the lead frame particularly when heated.

When forming a lead, make sure not to apply any stress inside the resin.

Lead forming must be done before soldering.

It is necessary to cut the lead frame at normal temperature.

7. Caution in ESD:

Static Electricity and surge damages the LED. It is recommend to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

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# Typical Electrical / Optical Characteristics Curves

(25 Ambient Temperature Unless Otherwise Noted)

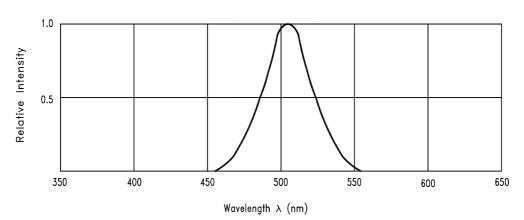
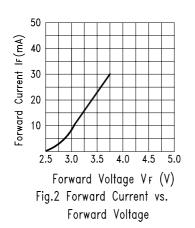
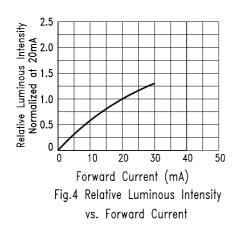
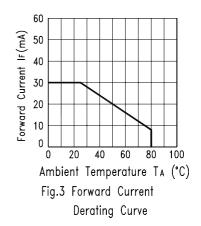


Fig.1 Relative Intensity vs. Wavelength







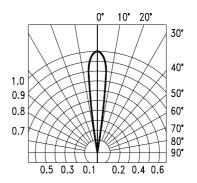


Fig.6 Spatial Distribution

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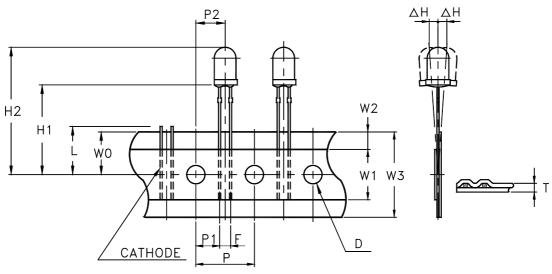


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#### **Features**

- \* Compatible with radial lead automatic insertion equipment.
- \* Most radial lead plastic lead lamps available packaged in tape and folding.
- \* 2.54mm (0.1") straight lead spacing available.
- \* Folding packaging simplifies handling and testing. Reel packaging is available by removing suffix "A" on option.

# **Package Dimensions**



TAPE FEED DIRECTION

		Specification			
Item	Symbol	Minimum		Maximum	
		mm	inch	mm	inch
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165
Component Lead Pitch	F	2.3	0.091	3.0	0.118
Front to Rear Deflection	Н			2.0	0.078
Feed Hole to Bottom of Component	H1	20.0	0.787	21.0	0.827
Feed Hole to Overall Component Height	H2	28.4	1.118	30.0	1.181
Lead Length After Component Height	L	W0		11.0	0.433
Feed Hole Pitch	P	12.4	0.488	13.0	0.511
Lead Location	P1	4.4	0.173	5.8	0.228
Center of Component Location	P2	5.05	0.198	7.65	0.301
Total Tape Thickness	T			0.90	0.035
Feed Hole Location	W0	8.5	0.334	9.75	0.384
Adhesive Tape Width	W1	14.5	0.571	15.5	0.610
Adhesive Tape Position	W2	0	0	3.0	0.118
Tape Width	W3	17.5	0.689	19.0	0.748

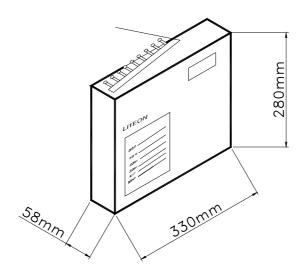
Part No.: LTL2H3TCKS7-032A Page: 5 of 11



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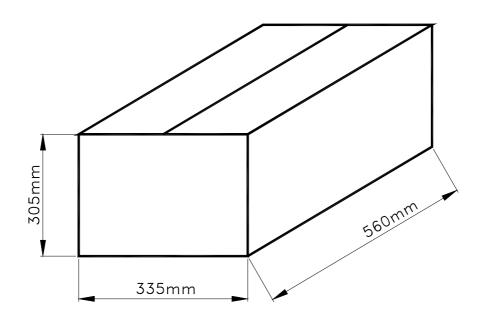
# **Packing Spec**

2000 pcs per inner carton



Tolerance: ±5mm

10 Inner cartons per outer carton total 20000 pcs per outer carton In every shipping lot, only the last pack will be non-full packing.



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## **Bin Code List For Reference**

Luminous Intensity Iv(mcd) IF@20mA		
Bin Code	Min.	Max.
V	4200	5500
W	5500	7200
X	7200	9300
Y	9300	12000
Z	12000	16000
5A	16000	21000

Note: Tolerance of each bin limit is  $\pm 15\%$ 

Forward Voltage Vf (Volts) IF@20mA		
Bin Code	Min.	Max.
4	3.00	3.25
5	3.25	3.50
6	3.50	3.75
7	3.75	4.00
8	4.00	4.25

Dominant	IF@20mA	
Bin Code	Min.	Max.
A	498	503
В	503	508

Note: Tolerance of each bin limit is  $\pm 1$ nm

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#### **CAUTIONS**

### 1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

#### 2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

#### 3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

### 4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens.

Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

#### 5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point.

Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering iron		Wave soldering		
Temperature Soldering time	300°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 10 sec. Max.	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product.

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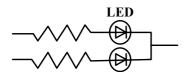
Property of Lite-On Only

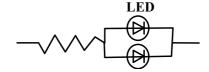
#### 6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A

Circuit model B





- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

### 7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

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### Suggested checking list:

#### Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

#### Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

#### Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V\*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: \*50V for Blue LED.

### Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

#### Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

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# 8. Reliability Test

Classification	Test Item	Test Condition	Reference Standard	
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)	
	High Temperature High Humidity Storage	Ta= 65±5 RH= 90 95% Test Time= 240HRS±2HRS	MIL-STD-202F: 103B(1980) JIS C 7021 : B-11(1982)	
Endurance Test	High Temperature High Humidity Reverse BIAS	Ta= 65±5 RH= 90 95% VR=5V Test Time = 500HRS (-24HRS, +48HRS)	JIS C 7021 : B-11(1982)	
	High Temperature Storage	Ta= 105±5 *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)	
	Low Temperature Storage	Ta= -55±5 *Test Time=1000HRS (-24HRS,+72HRS)	JIS C 7021:B-12 (1982)	
	Temperature Cycling	105 25 -55 25 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021: A-4(1982)	
Environmental Test	Thermal Shock	105 ± 5 -55 ± 5 10mins 10mins 10 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)	
	Solder Resistance	$T.sol = 260 \pm 5$ $Dwell Time= 10 \pm 1 secs$	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021: A-1(1982)	
	Solderability	T. sol = $230 \pm 5$ Dwell Time= $5 \pm 1$ secs	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) JIS C 7021: A-2(1982)	

## 9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

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